

[54] **MICROPHONE**

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[73] **Assignee: Sony Corporation, Tokyo, Japan**

[**] **Term: 14 Years**

[21] **Appl. No.: 768,471**

[22] **Filed: Aug. 22, 1985**

[30] **Foreign Application Priority Data**

Mar. 26, 1985 [JP] Japan 60-12033
[52] **U.S. Cl.** **D14/227**
[58] **Field of Search** **D14/3, 12, 13, 99;**
381/91, 122, 155, 159, 168, 169, 170

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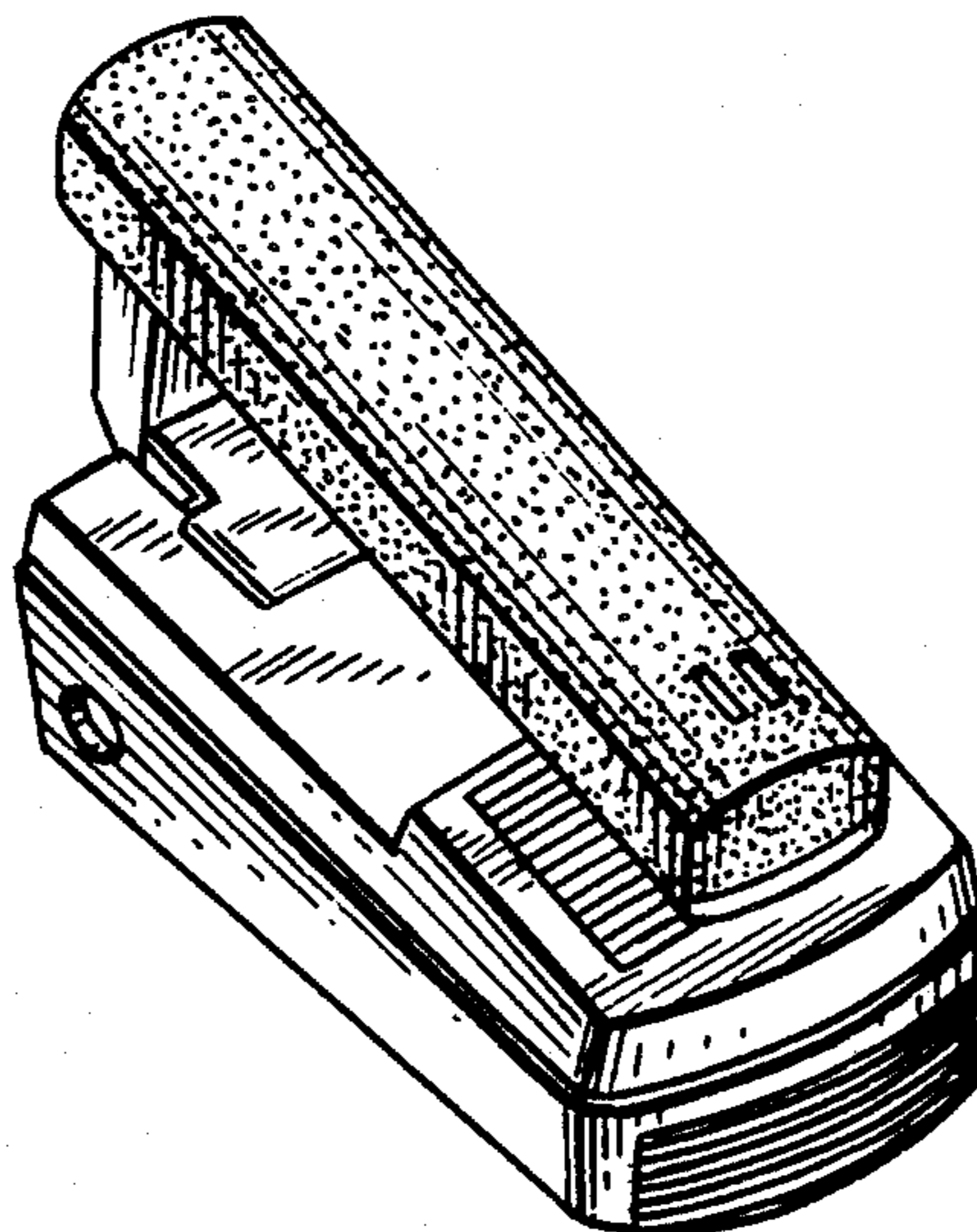
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[57] **CLAIM**

The ornamental design for a microphone, as shown and described.

DESCRIPTION

FIG. 1 is a top, front, and left-side perspective view of a microphone showing my new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left-side elevational view thereof;
FIG. 5 is a right-side elevational view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof; and
FIG. 8 is a top, rear, and right-side perspective view thereof, the broken line showing of the jacket lapel is for environmental purposes only and forms no part of the claimed design.



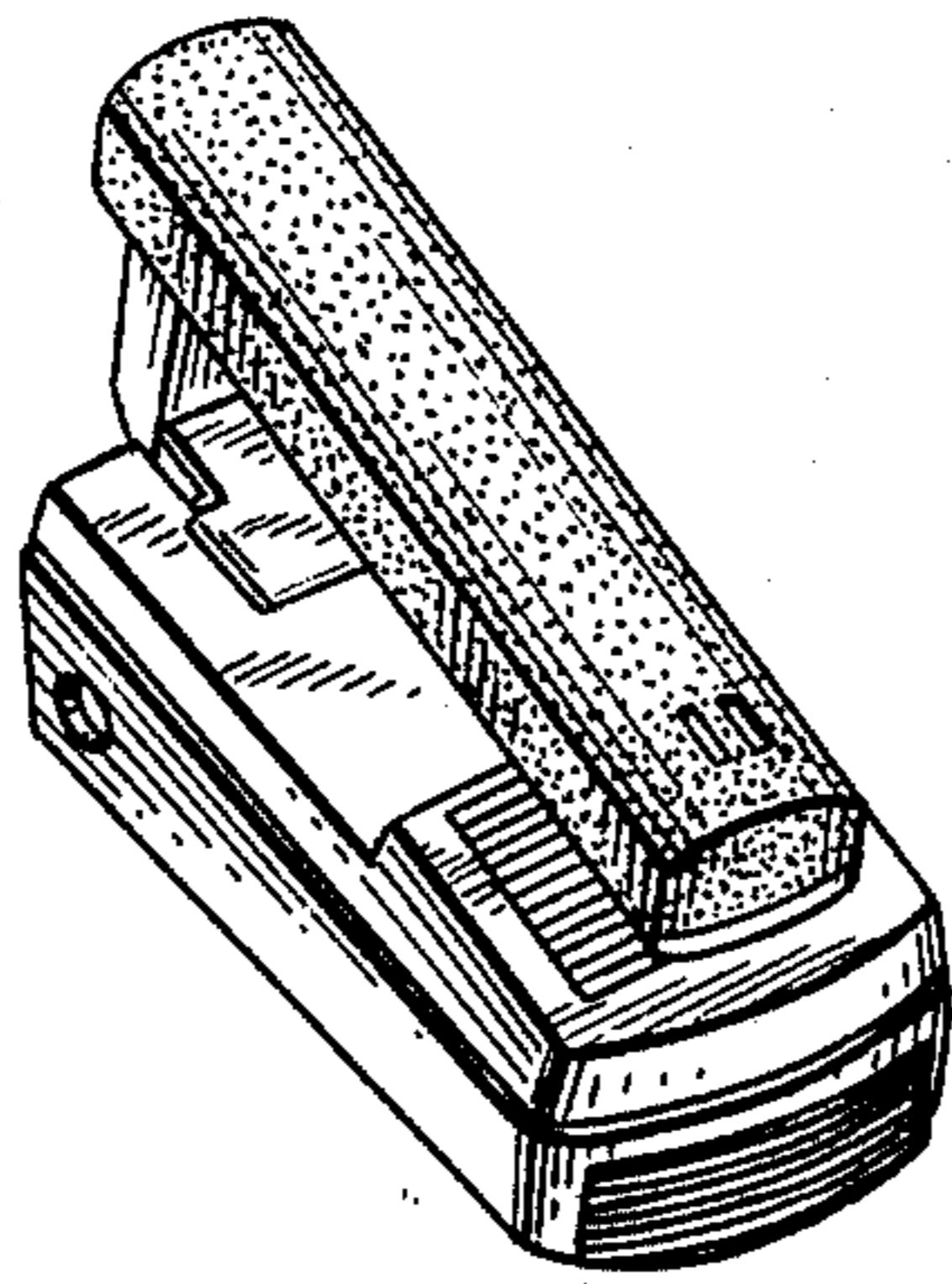


FIG. 1

FIG. 2

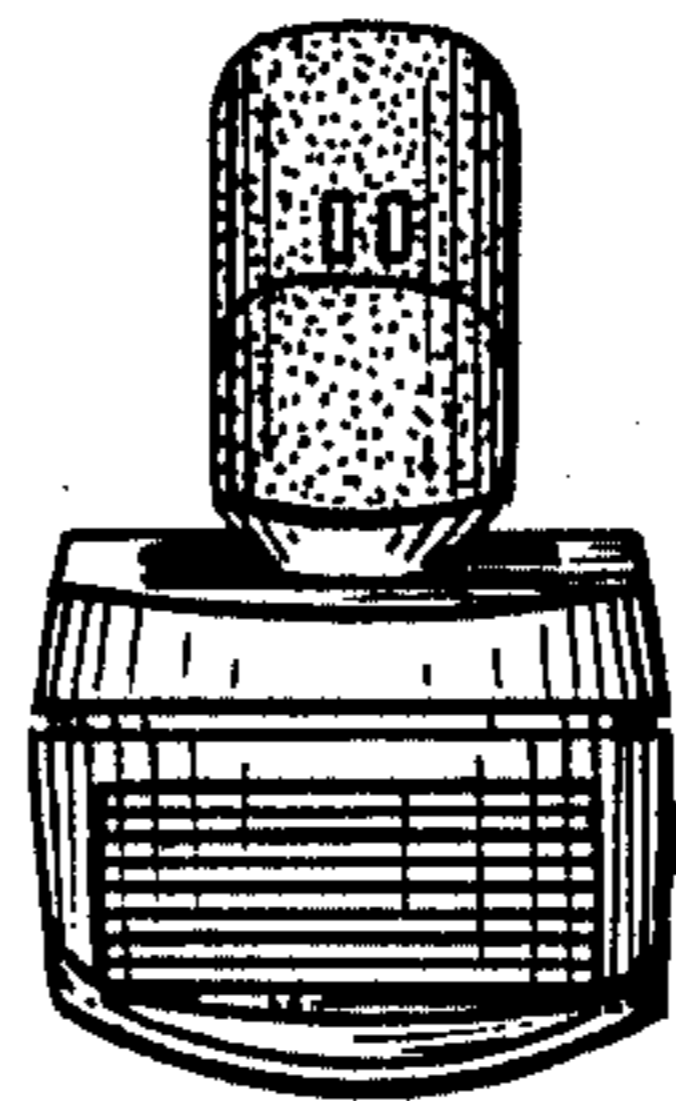


FIG. 3

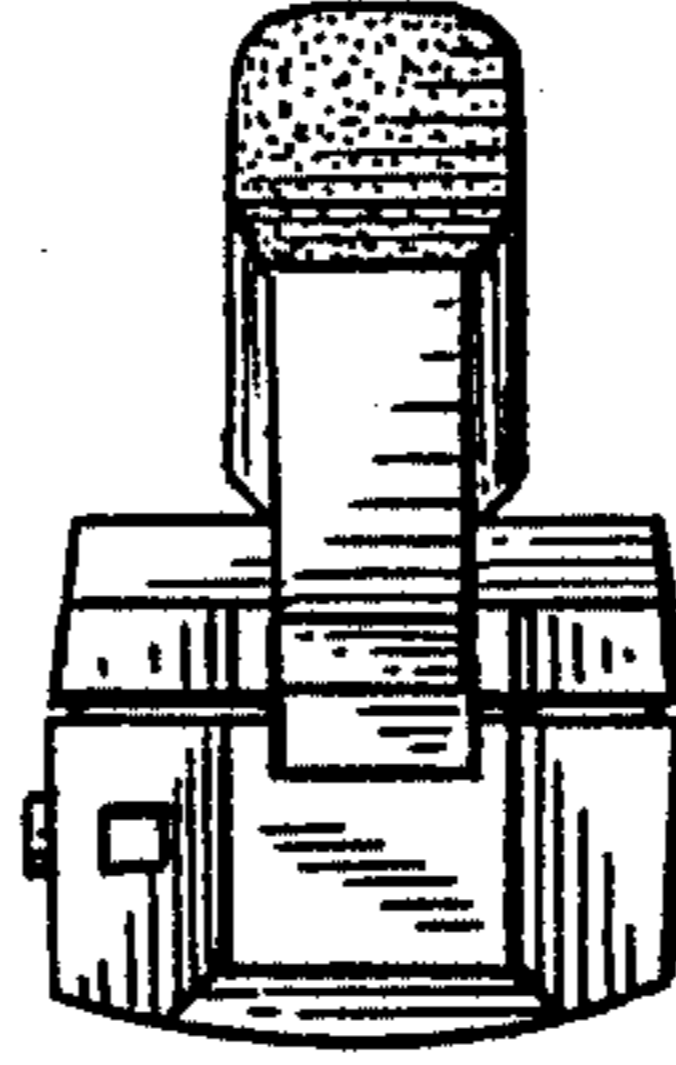


FIG. 4

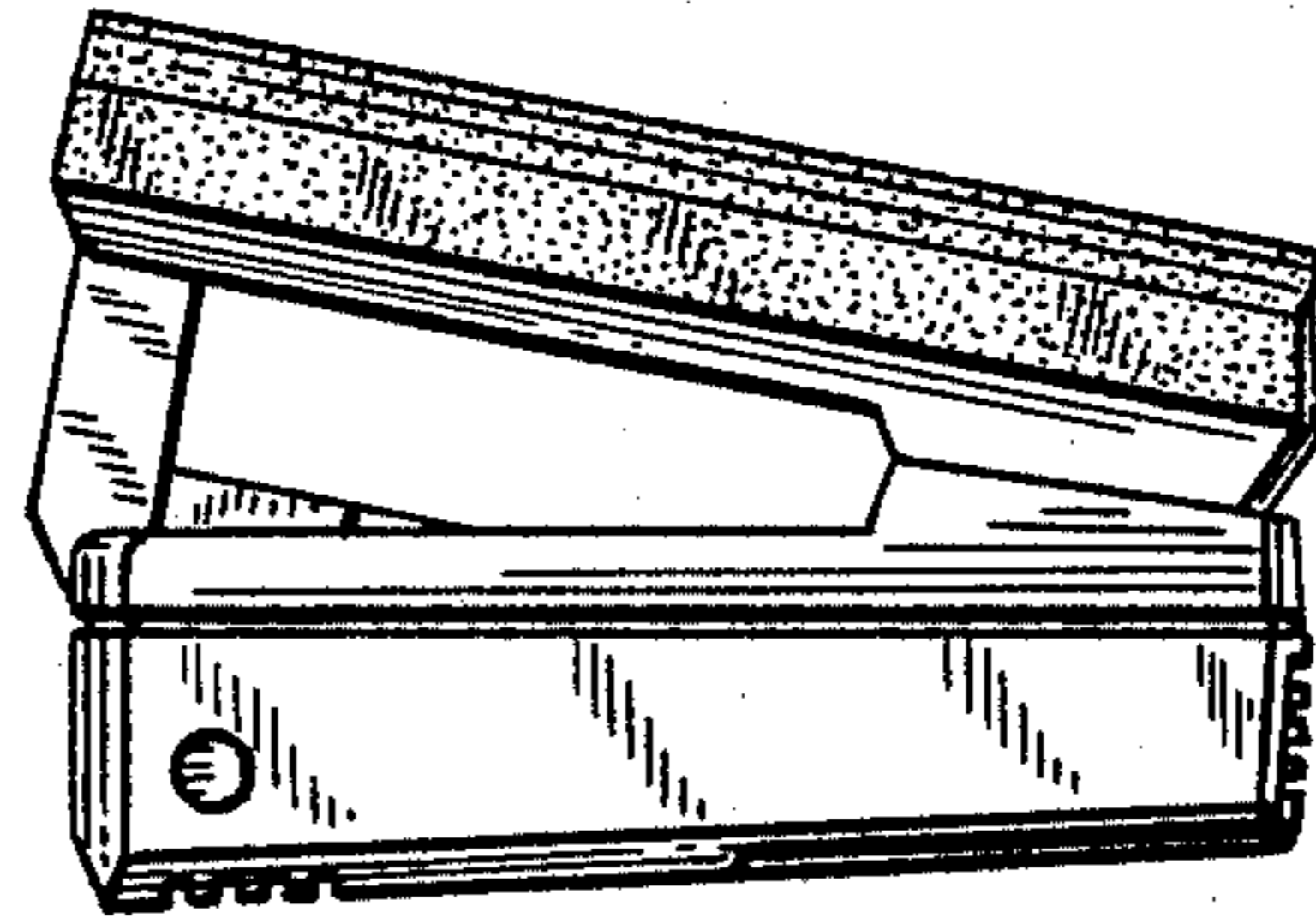


FIG. 5

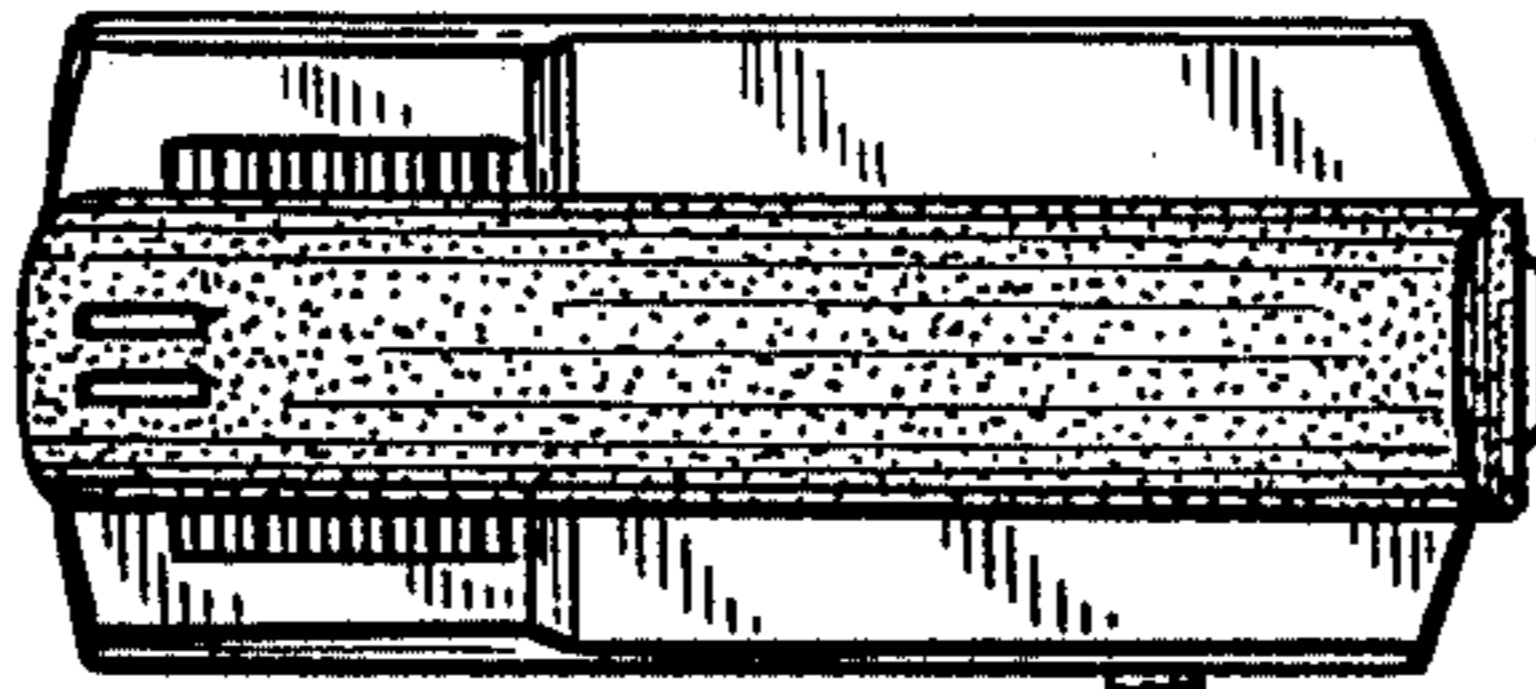
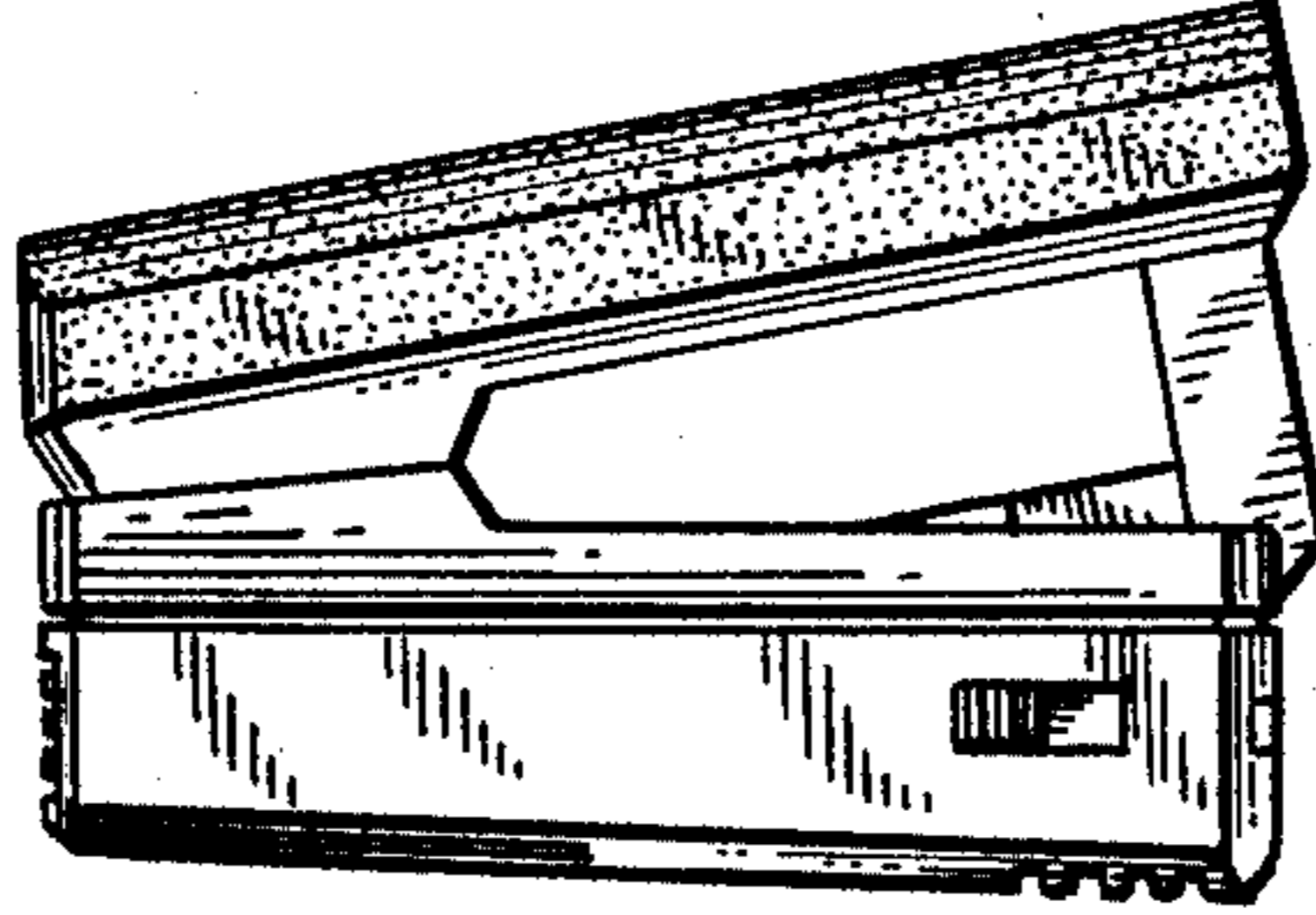


FIG. 6

FIG. 7

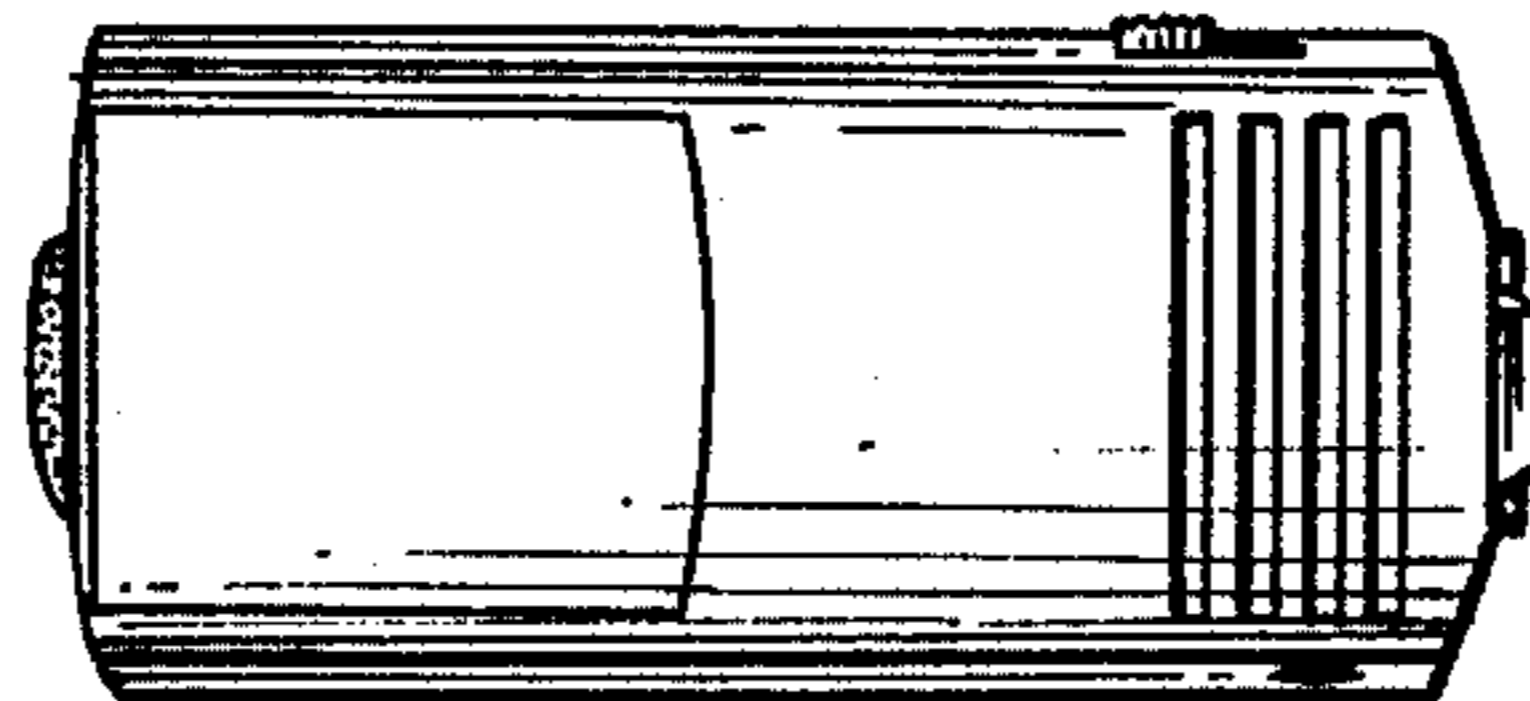


FIG. 8

